# **DMG204B1**

## Silicon NPN epitaxial planar type (Tr1) Silicon PNP epitaxial planar type (Tr2)

For low frequency amplification

#### ■ Features

- High forward current transfer ratio h<sub>FE</sub> with excellent linearity
- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- Halogen-free / RoHS compliant
   (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### ■ Marking Symbol: C5

#### ■ Basic Part Number

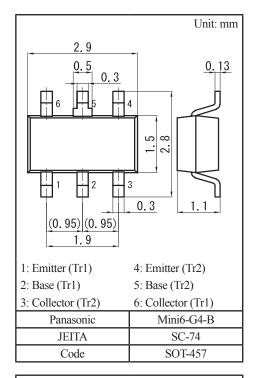
DSC2501 + DSA2001 (Individual)

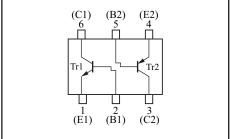
#### Packaging

DMG204B10R Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

	Parameter	Symbol	Rating	Unit
Tr1	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	25	V
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V
	Emitter-base voltage (Collector open)	V <sub>EBO</sub>	12	V
	Collector current	$I_{C}$	0.5	A
	Peak collector current	I <sub>CP</sub>	1	A
Tr2	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-60	V
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-50	V
	Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-7	V
	Collector current	$I_{C}$	-100	mA
	Peak collector current	$I_{CP}$	-200	mA
	Total power dissipation	P <sub>T</sub>	300	mW
Overall	Junction temperature	$T_j$	150	°C
	Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C
	Storage temperature	T <sub>stg</sub>	-55 to +150	°C





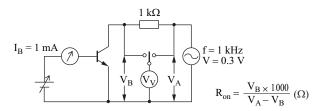
### ■ Electrical Characteristics $T_a = 25$ °C±3°C

#### • Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \mu A, I_E = 0$	25			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	20			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu A, I_C = 0$	12			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$			100	nA
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	200		800	_
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_{\rm C} = 0.5  \text{A}, I_{\rm B} = 20  \text{mA}$		0.18	0.40	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 50 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}, I_{C} = 50 \text{ mA}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		6		pF
ON resistance *2	R <sub>on</sub>			1.0		Ω

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

- 2. \*1: Pulse measurement
  - \*2: Ron measurement circuit



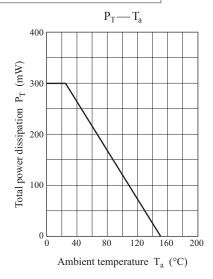
#### • Tr2

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = -10  \mu \text{A}, I_{\rm E} = 0$	-60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_E = -10 \mu A, I_C = 0$	-7			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{\rm CB} = -20 \text{ V}, I_{\rm E} = 0$			-0.1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = -10 \text{ V}, I_{B} = 0$			-100	μΑ
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$	210		460	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$		-0.2	-0.5	V
Transition frequency	$f_T$	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2		pF

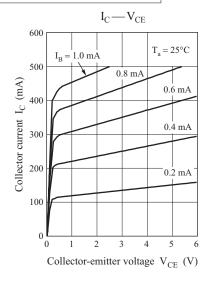
 $Note)\ Measuring\ methods\ are\ based\ on\ JAPANESE\ INDUSTRIAL\ STANDARD\ JIS\ C\ 7030\ measuring\ methods\ for\ transistors.$ 

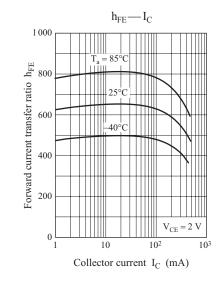
Ver. CED 2

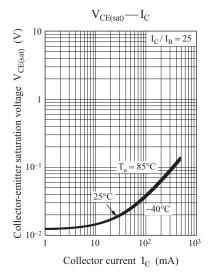
#### Common characteristics chart

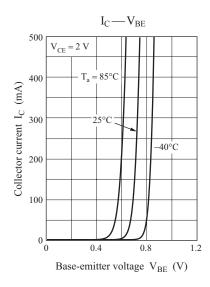


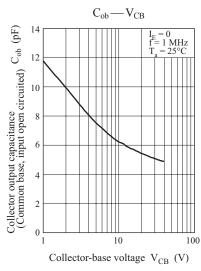
#### Characteristics charts of Tr1

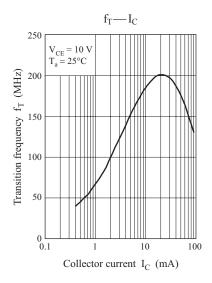


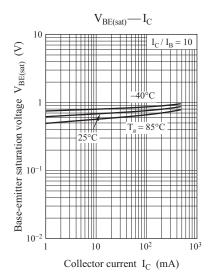




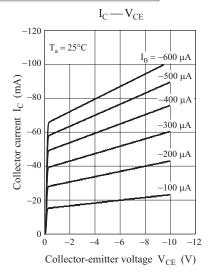


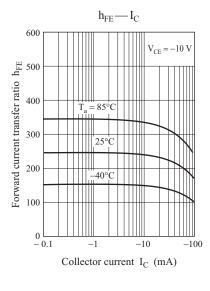


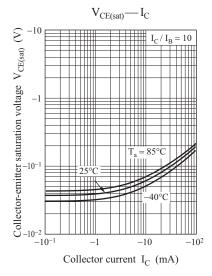


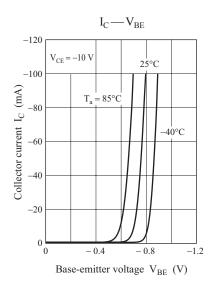


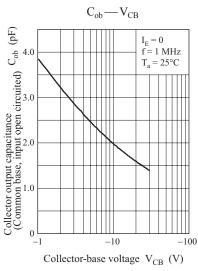
#### Characteristics charts of Tr2

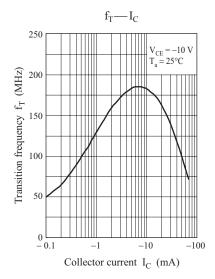






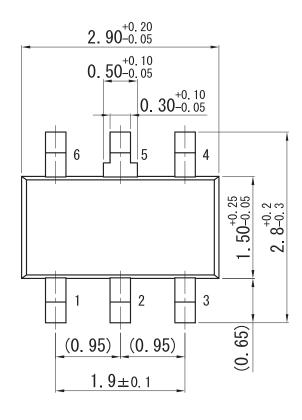


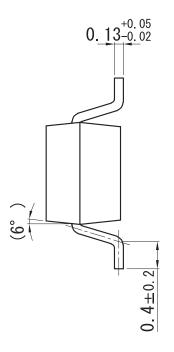


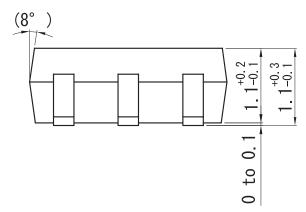


Mini6-G4-B

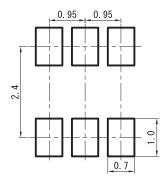
Unit: mm







#### ■ Land Pattern (Reference) (Unit: mm)



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